CPC1965G
AC Solid State Relay

Parameter	Rating	Units
AC Operating Voltage	260	V_{rms}
Load Current	1	A_{rms}
On State Voltage Drop	1.6	V_{rms} (at I_L = $1A_{rms}$)

Features
- Load Current up to $1A_{rms}$
- $600V_P$ Blocking Voltage
- 5mA Sensitivity
- Zero-Crossing Detection
- DC Control, AC Output
- Optically Isolated
- TTL and CMOS Compatible
- Low EMI and RFI Generation
- High Noise Immunity
- Machine Insertable, Wave Solderable
- Flammability Classification Rating of V-0

Applications
- Programmable Control
- Process Control
- Power Control Panels
- Remote Switching
- Gas Pump Electronics
- Contactors
- Large Relays
- Solenoids
- Motors
- Heaters

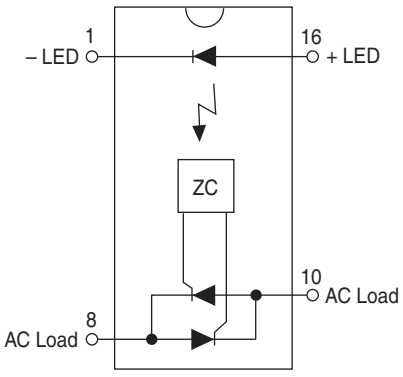
Description
The CPC1965G is an AC Solid State Switch using patented waveguide coupling with dual power SCR outputs to produce an alternative to optocoupler and Triac circuits. The switches are robust enough to provide a blocking voltage of up to $600V_P$. In addition, tightly controlled zero-cross circuitry ensures switching of AC loads without the generation of transients. The input and output circuits are optically coupled to provide $3750V_{rms}$ of isolation and noise immunity between control and load circuits. As a result, the CPC1965G is well suited for industrial environments where electromagnetic interference could disrupt the operation of electromechanical relays.

Approvals
- UL Recognized Component: File E69938
- CSA Certified Component: Certificate 1172007

Ordering Information

Part #	Description
CPC1965G	4-Pin (16-Pin Body) DIP (25/Tube)

Pin Configuration



Absolute Maximum Ratings @ 25ºC

Parameter	Ratings	Units
Blocking Voltage	600	V_P
Reverse Input Voltage	5	V
Input Control Current	100	mA
Peak (10ms)	1	A
Input Power Dissipation [1]	150	mW
PD , Total Package Dissipation [2]	1600	mW
Isolation Voltage, Input to Output	3750	V_{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

1 Derate linearly 1.33 mW / ºC
2 Derate linearly 16.6 mW / ºC

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

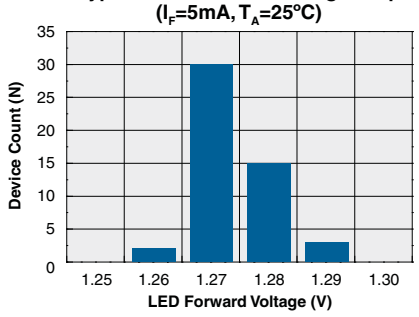
Electrical Characteristics @ 25ºC

Parameters	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Operating Voltage Range	V_L	-	20	-	260	V_{rms}
Load Current, Continuous	V_L=120-260V_{rms}	I_L	0.005	-	1.0	A_{rms}
Non-Repetitive Single Cycle Surge Current	-	I_{TSM}	-	-	10	A
Off State Leakage Current	V_L=600V_P	I_{LEAK}	-	-	1	mA
On-State Voltage Drop	I_L=1A_{rms}		-	-	1.6	V_{rms}
Critical Rate of Rise [3]	-	dV/dt	1000	-	-	V/µs
Switching Speeds						
Turn-on	I_F=5 mA	t_{on}	-	-	0.5	cycles
Turn-off		t_{off}	-	-	0.5	
Zero-Cross Turn-On Voltage	1st half-cycle	-	-	2	10	V
	Subsequent half-cycle	-	-	1	-	V
Operating Frequency [1]	-	-	20	-	400	Hz
Load Power Factor for Guaranteed Turn-On [2]	-	PF	0.25	-	-	-
Input Characteristics						
Input Control Current [4]	-	I_F	-	0.8	5	mA
Input Voltage Drop	I_F=5mA	V_F	0.9	1.2	1.4	V
Input Drop-out Voltage	-	-	0.8	-	-	V
Reverse Input Current	V_R=5V	I_R	-	-	10	µA
Common Characteristics						
Input to Output Capacitance	-	$C_{I/O}$	-	3	-	pF

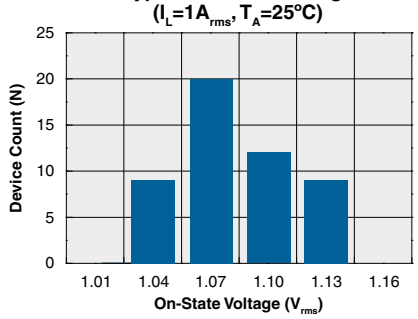
[1] Zero Cross 1st half-cycle @ <100Hz
[2] Snubber circuits may be required at low power factors.
[3] Tested in accordance with EIA/NARM standard RS-443.
[4] For high noise environments, use I_F=10mA.

PERFORMANCE DATA*

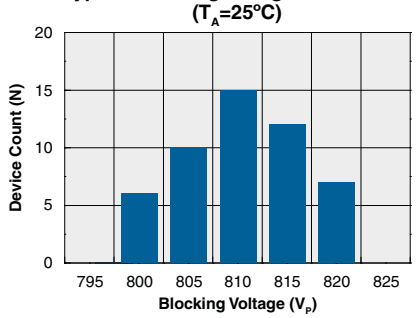
Typical LED Forward Voltage Drop (I_F=5mA, T_A=25°C)



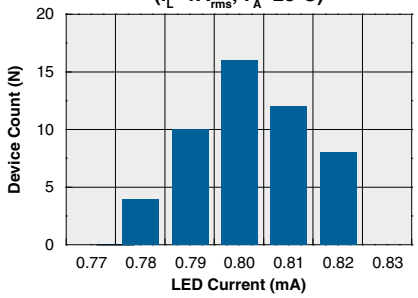
Typical On-State Voltage (I_L=1A_{rms}, T_A=25°C)



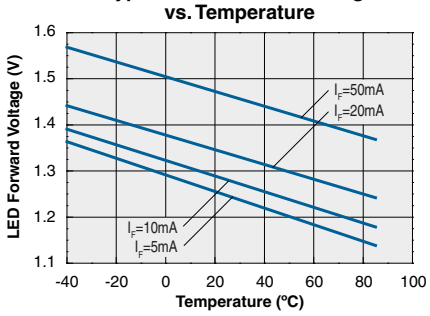
Typical Blocking Voltage Distribution (T_A=25°C)



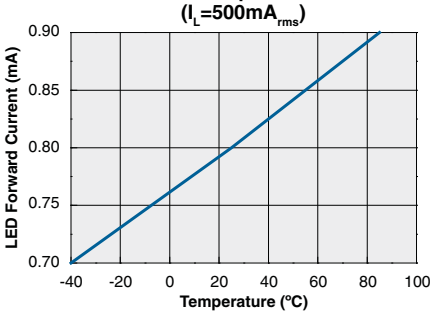
Typical I_F for Switch Operation (I_L=1A_{rms}, T_A=25°C)



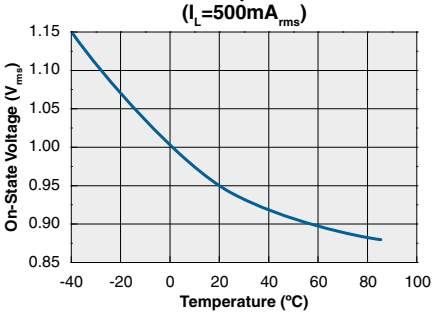
Typical LED Forward Voltage vs. Temperature



Typical I_F for Switch Operation vs. Temperature (I_L=500mA_{rms})



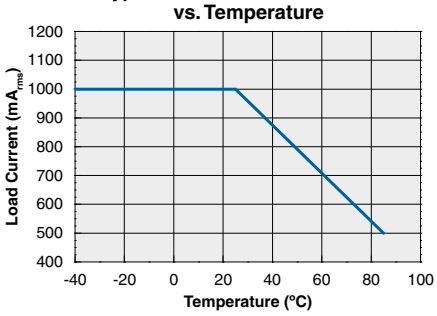
Typical On-State Voltage vs. Temperature (I_L=500mA_{rms})



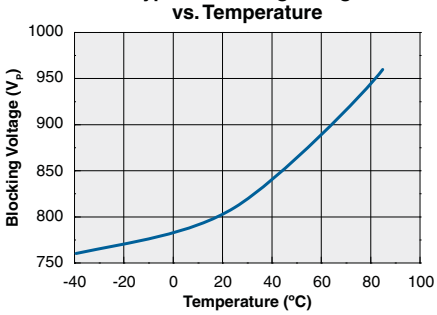
*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*

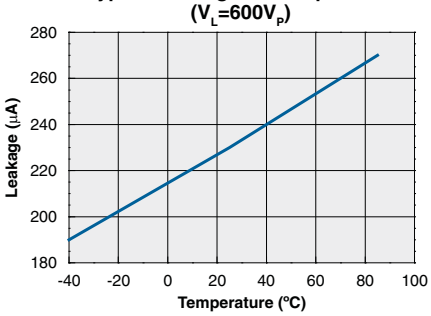
Typical Maximum Load Current vs. Temperature



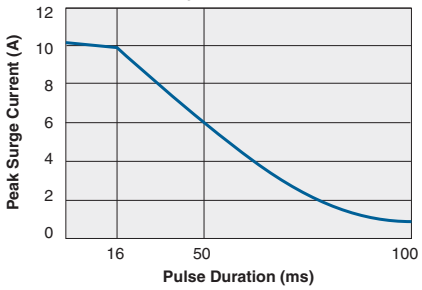
Typical Blocking Voltage vs. Temperature



Typical Leakage vs. Temperature (V_L=600V_P)



Maximum Surge Current (Non-Repetitive) (T_J=50°C max)



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Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1965G	MSL 1

ESD Sensitivity

This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

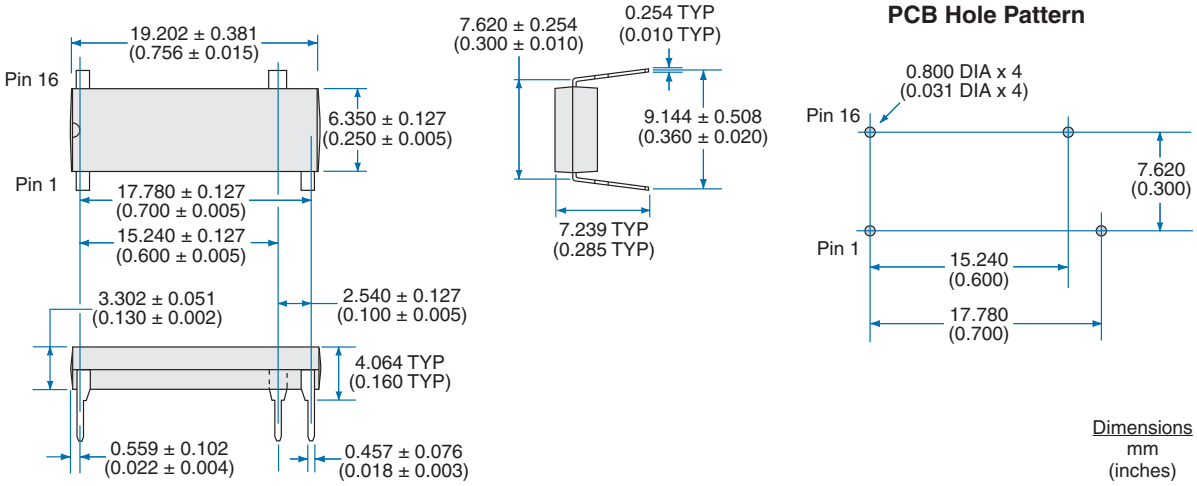
Device	Maximum Temperature x Time
CPC1965G	245°C for 30 seconds

Board Wash

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since Clare employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake may be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

MECHANICAL DIMENSIONS

CPC1965G



Dimensions
mm
(inches)

For additional information please visit our website at: www.clare.com

Specification: DS-CPC1965G-R05

1/7/2011